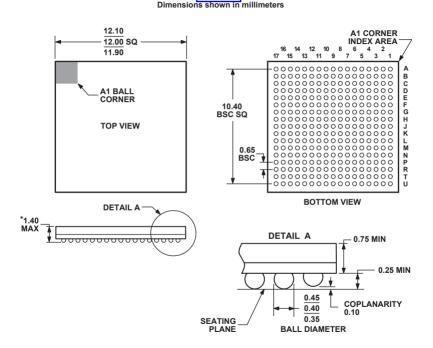
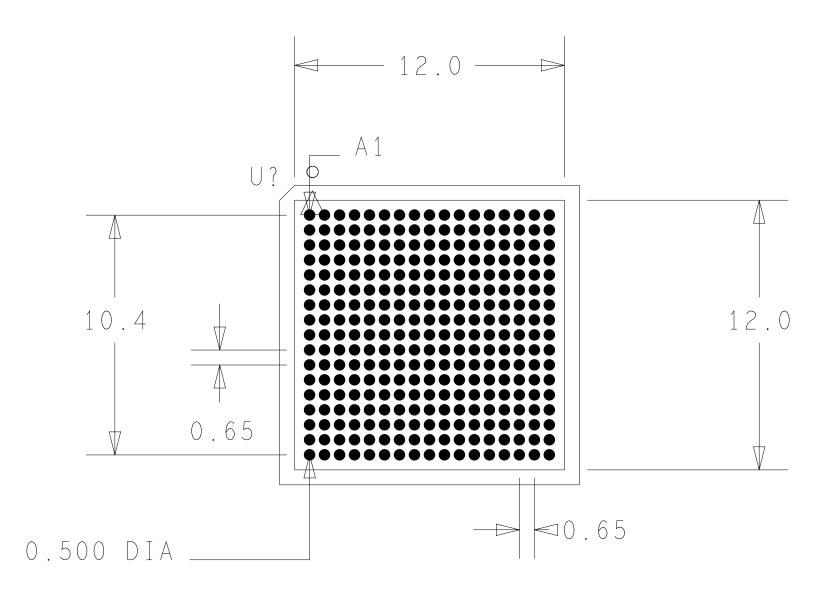
ANALOG

289-Ball Chip Scale Package Ball Grid Array [CSP_BGA] (BC-289-1)



*COMPLIANT TO JEDEC STANDARDS MO-246 WITH THE EXCEPTION TO PACKAGE HEIGHT AND NO EXACT BALL COUNT.

Analog Devices BC-289-1 REVA



(Dim. are in MM)
LAST MODIFIED 09/14/07